DOSEMI

IGBT

DG120X07T2

650V/120A IGBT with Diode

General Description

DOSEMI IGBT Power Discrete provides ultra low conduction loss as well as low switching loss. They are designed for the applications such as general inverters and UPS.

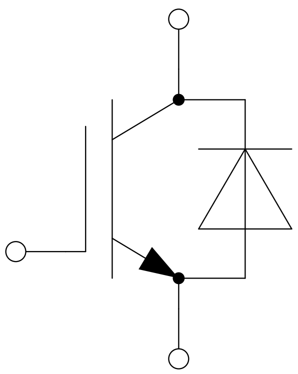
Features

- Low $V_{CE(sat)}$ Trench IGBT technology
- Low switching loss
- Maximum junction temperature 175°C
- $V_{CE(sat)}$ with positive temperature coefficient
- Fast & soft reverse recovery anti-parallel FWD
- Lead free package

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Equivalent Circuit Schematic



Absolute Maximum Ratings T_C=25°C unless otherwise noted

IGBT

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	650	V
V_{GES}	Gate-Emitter Voltage	±20	V
I_C	Collector Current @ T_C=25°C @ T_C=135°C	240 120	A
I_{CM}	Pulsed Collector Current t_p limited by T_{jmax}	360	A
P_D	Maximum Power Dissipation @ T_j=175°C	893	W

Diode

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	650	V
I_F	Diode Continuous Forward Current @ T_C=25°C @ T_C=80°C	177 120	A
I_{FM}	Diode Maximum Forward Current t_p limited by T_{jmax}	360	A

Discrete

Symbol	Description	Values	Unit
T_{jop}	Operating Junction Temperature	-40 to +175	°C
T_{STG}	Storage Temperature Range	-55 to +150	°C
T_S	Soldering Temperature,1.6mm from case for 10s	260	°C

IGBT Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	I_C=120A,V_{GE}=15V, T_j=25°C		1.40	1.85	V
		I_C=120A,V_{GE}=15V, T_j=150°C		1.70		
		I_C=120A,V_{GE}=15V, T_j=175°C		1.75		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	I_C=1.92mA,V_{CE}=V_{GE}, T_j=25°C	5.1	5.8	6.5	V
I_{CES}	Collector Cut-Off Current	V_{CE}=V_{CES},V_{GE}=0V, T_j=25°C			250	uA
I_{GES}	Gate-Emitter Leakage Current	V_{GE}=V_{GES},V_{CE}=0V, T_j=25°C			200	nA
R_{Gint}	Internal Gate Resistance			/		Ω
C_{ies}	Input Capacitance	V_{CE}=25V,f=100kHz, V_{GE}=0V		14.1		nF
C_{res}	Reverse Transfer Capacitance			0.42		nF
Q_G	Gate Charge	V_{GE}=-15…+15V		0.86		uC
$t_{d(on)}$	Turn-On Delay Time	V_{CC}=300V,I_C=120A, R_G=7.5Ω,V_{GE}= ±15V, L_S=40nH,T_j=25°C		68		ns
t_r	Rise Time			201		ns
$t_{d(off)}$	Turn-Off Delay Time			166		ns
t_f	Fall Time			54		ns
E_{on}	Turn-On Switching Loss			7.19		mJ
E_{off}	Turn-Off Switching Loss			2.56		mJ
$t_{d(on)}$	Turn-On Delay Time	V_{CC}=300V,I_C=120A, R_G=7.5Ω,V_{GE}= ±15V, L_S=40nH,T_j=150°C		70		ns
t_r	Rise Time			207		ns
$t_{d(off)}$	Turn-Off Delay Time			186		ns
t_f	Fall Time			106		ns
E_{on}	Turn-On Switching Loss			7.70		mJ
E_{off}	Turn-Off Switching Loss			2.89		mJ
$t_{d(on)}$	Turn-On Delay Time	V_{CC}=300V,I_C=120A, R_G=7.5Ω,V_{GE}= ±15V, L_S=40nH,T_j=175°C		71		ns
t_r	Rise Time			211		ns
$t_{d(off)}$	Turn-Off Delay Time			195		ns
t_f	Fall Time			139		ns
E_{on}	Turn-On Switching Loss			7.80		mJ
E_{off}	Turn-Off Switching Loss			2.98		mJ
I_{SC}	SC Data	t_P≤6μs,V_{GE}=15V, T_j=150 °C,V_{CC}=300V, V_{CEM}≤650V		600		A

Diode Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	I_F=120A,V_{GE}=0V,T_j=25°C		1.65	2.10	V
		I_F=120A,V_{GE}=0V,T_j=150°C		1.60		
		I_F=120A,V_{GE}=0V,T_j=175°C		1.60		
t_{rr}	Diode Reverse Recovery Time	V_R=300V,I_F=120A, -di/dt=450A/μs,V_{GE}=-15V L_S=40nH,T_j=25°C		184		ns
Q_r	Recovered Charge			1.65		μC
I_{RM}	Peak Reverse Recovery Current			17.2		A
E_{rec}	Reverse Recovery Energy			0.23		mJ
t_{rr}	Diode Reverse Recovery Time	V_R=300V,I_F=120A, -di/dt=450A/μs,V_{GE}=-15V L_S=40nH,T_j=150°C		221		ns
Q_r	Recovered Charge			3.24		μC
I_{RM}	Peak Reverse Recovery Current			23.1		A
E_{rec}	Reverse Recovery Energy			0.53		mJ
t_{rr}	Diode Reverse Recovery Time	V_R=300V,I_F=120A, -di/dt=450A/μs,V_{GE}=-15V L_S=40nH,T_j=175°C		246		ns
Q_r	Recovered Charge			3.98		μC
I_{RM}	Peak Reverse Recovery Current			26.8		A
E_{rec}	Reverse Recovery Energy			0.64		mJ

Discrete Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
R_{thJC}	Junction-to-Case (per IGBT) Junction-to-Case (per Diode)			0.168 0.369	K/W
R_{thJA}	Junction-to-Ambient		40		K/W

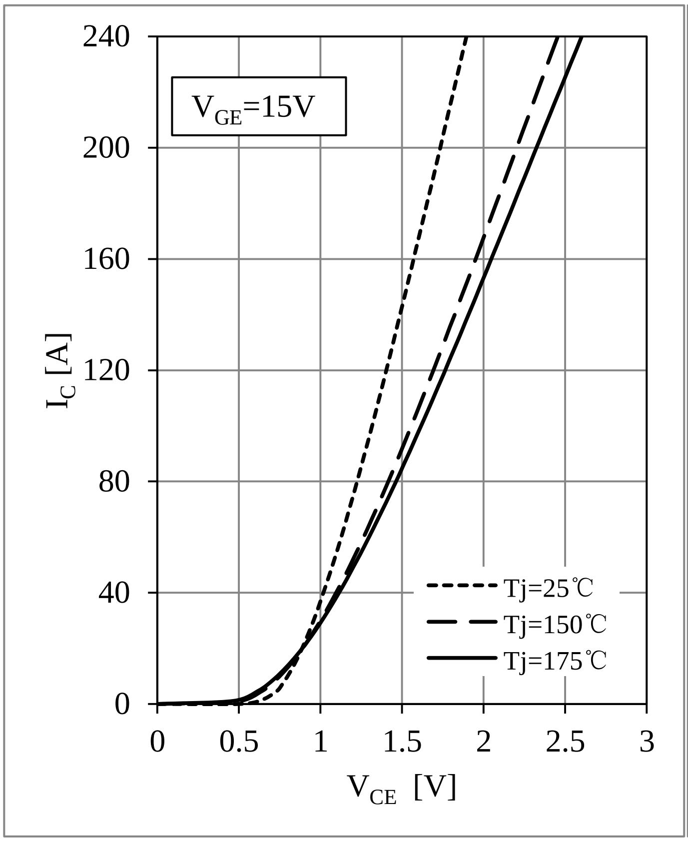


Fig 1. IGBT-inverter Output Characteristics

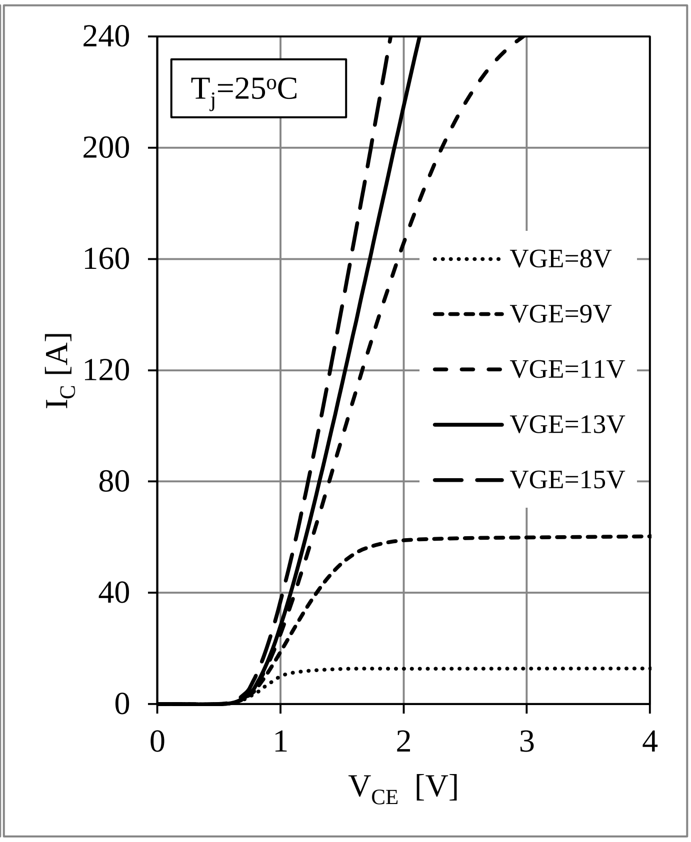


Fig 2. IGBT Output Characteristics

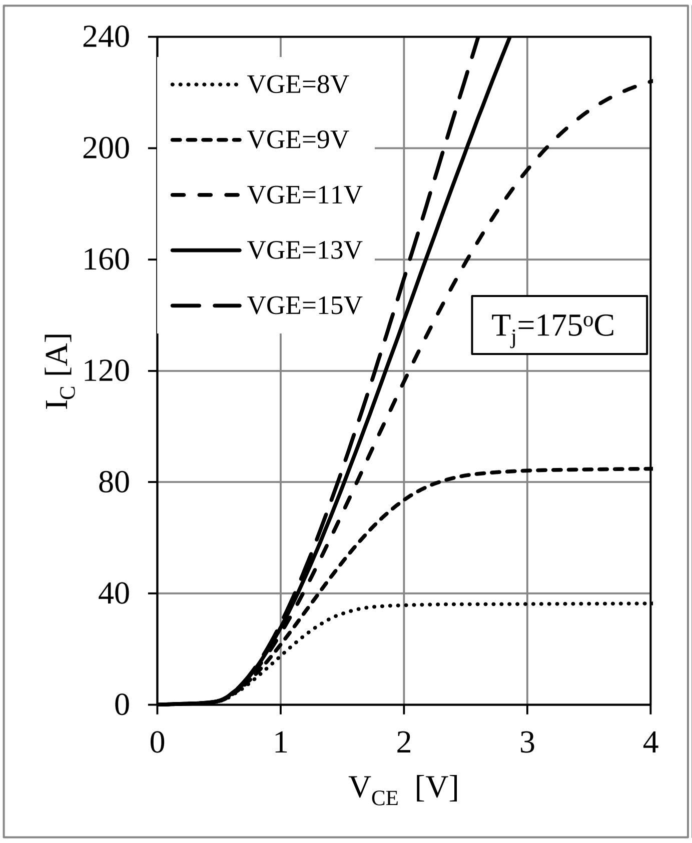


Fig 3. IGBT Output Characteristics

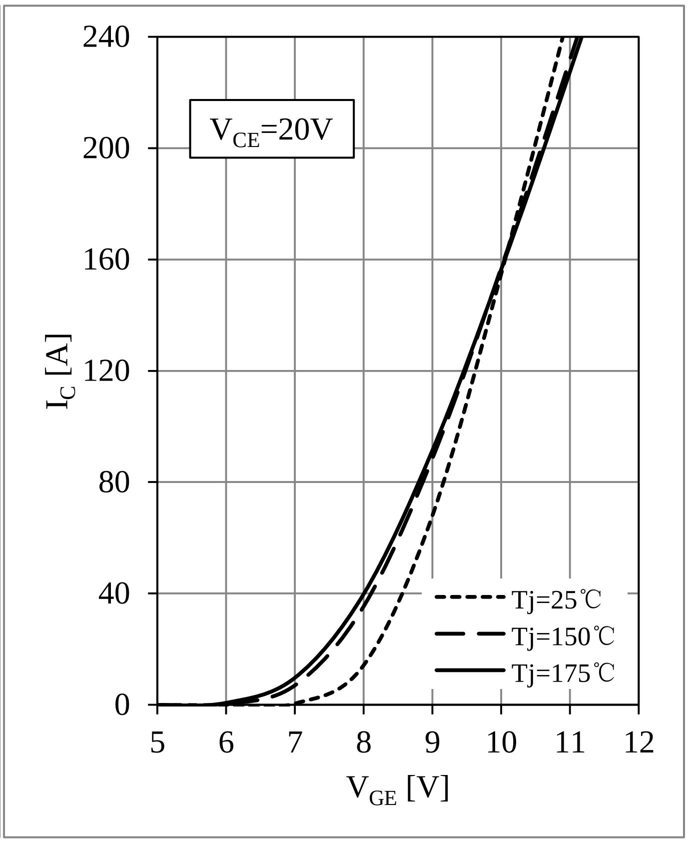


Fig 4. IGBT Transfer Characteristics

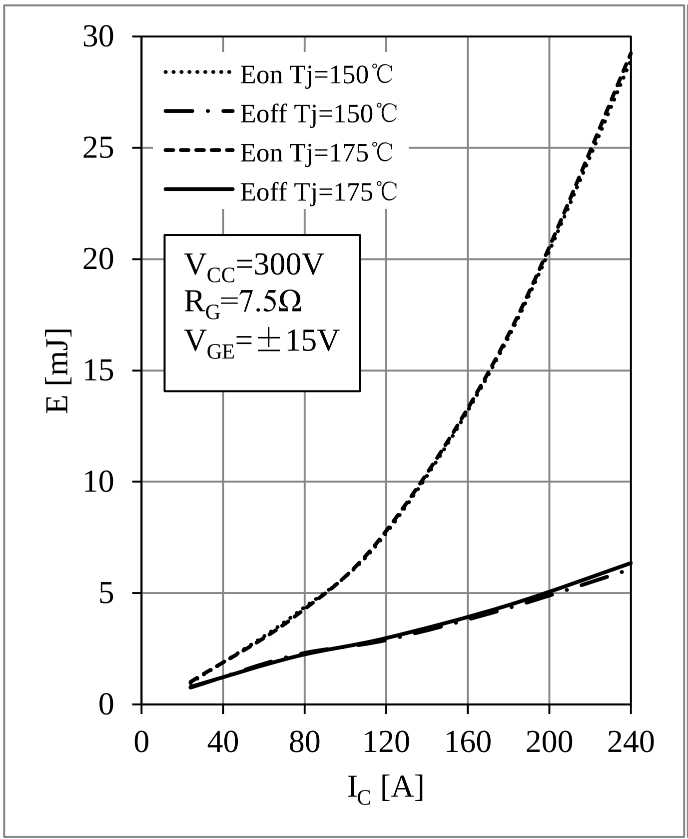


Fig 5. IGBT Switching Loss vs. I_C

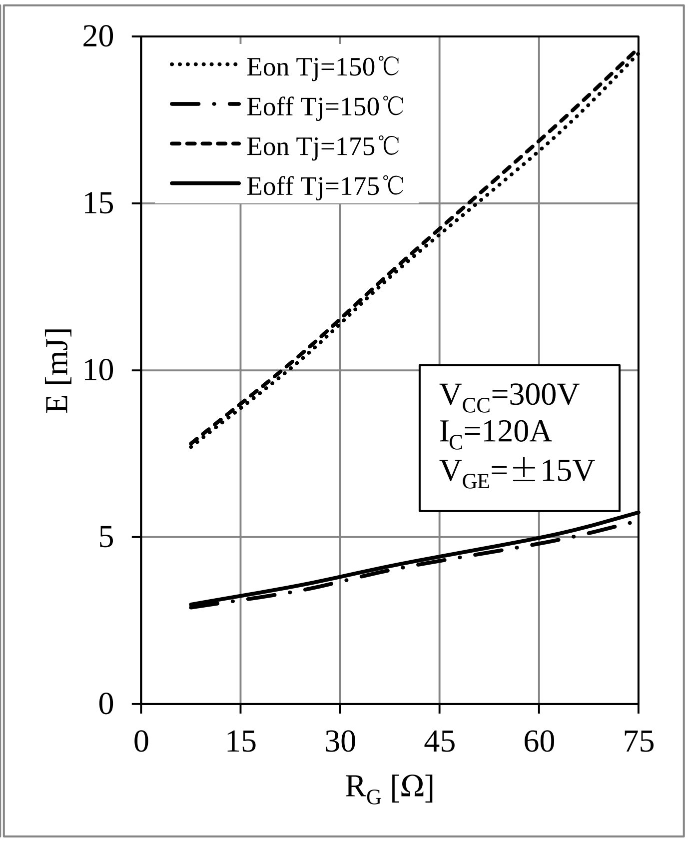


Fig 6. IGBT Switching Loss vs. R_G

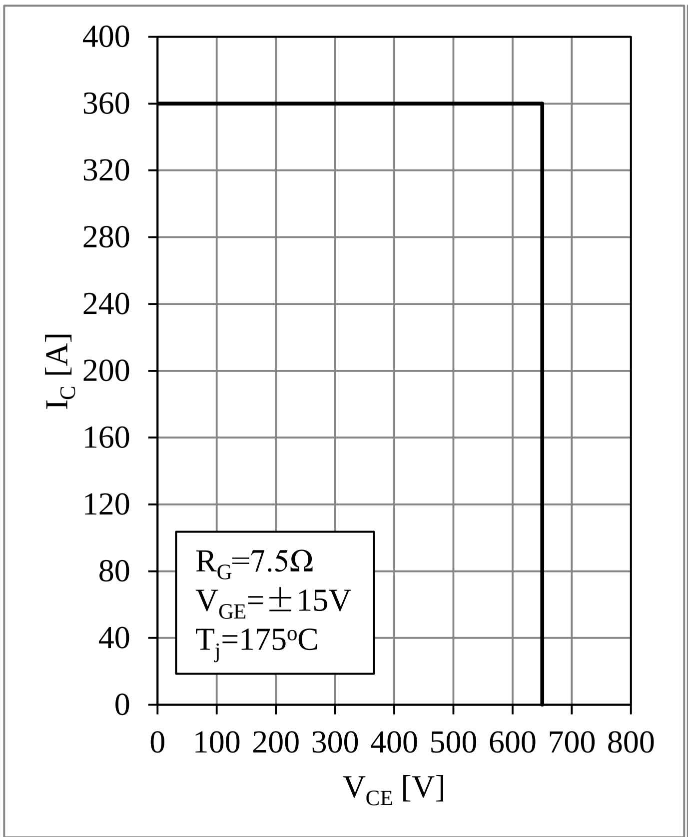


Fig 7. RBSOA

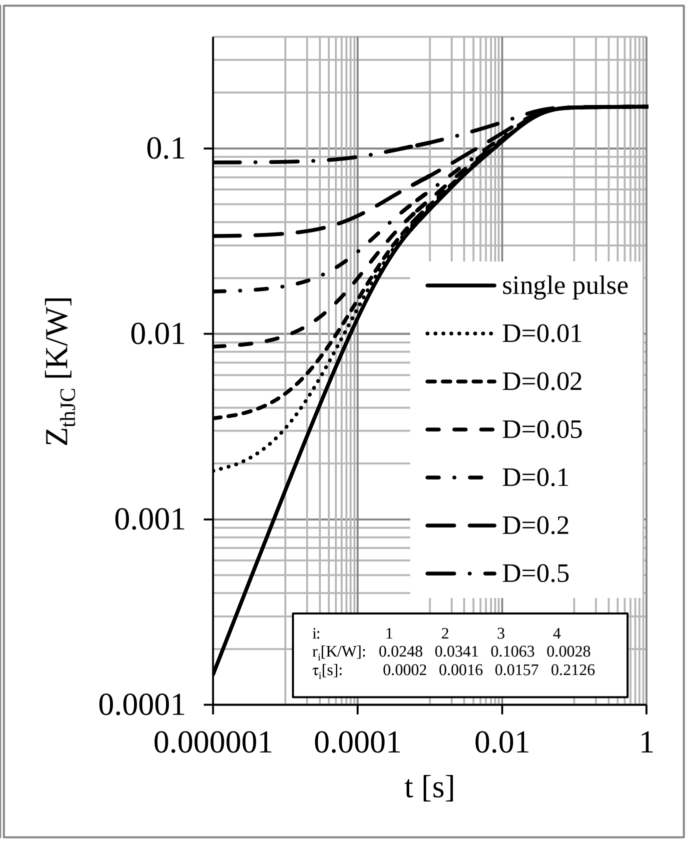


Fig 8. IGBT Transient Thermal Impedance

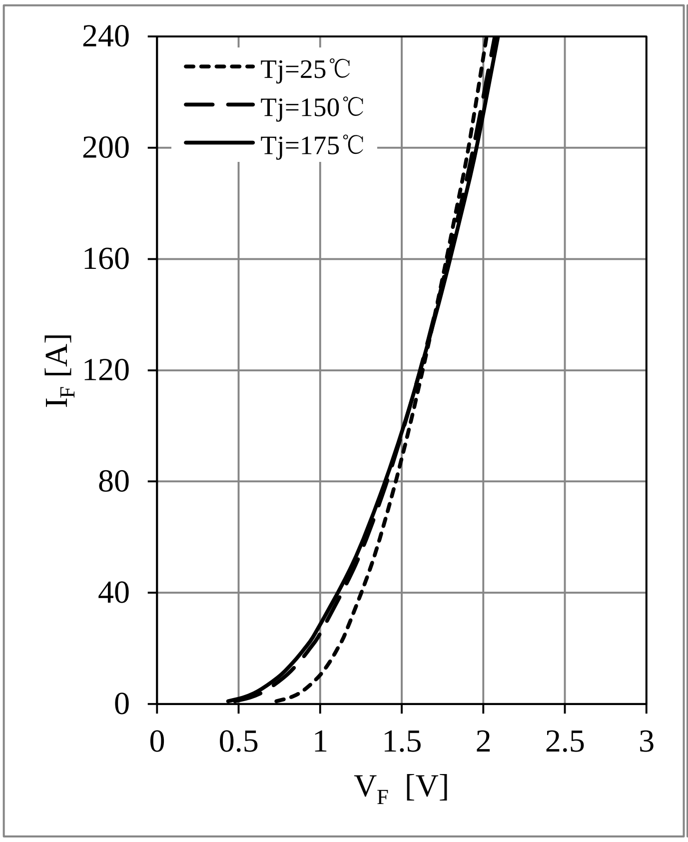


Fig 9. Diode Forward Characteristics

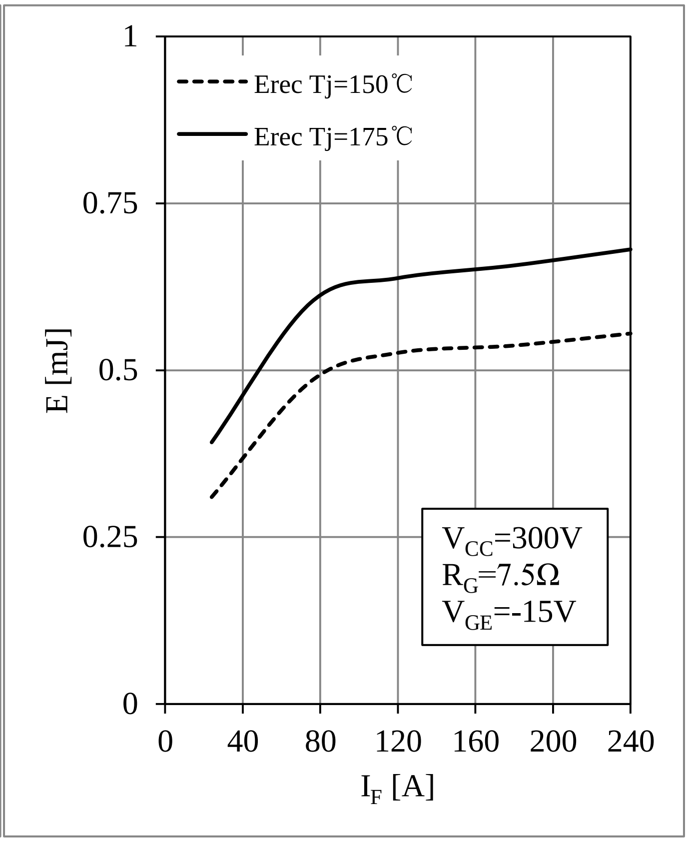


Fig 10. Diode Switching Loss vs. I_F

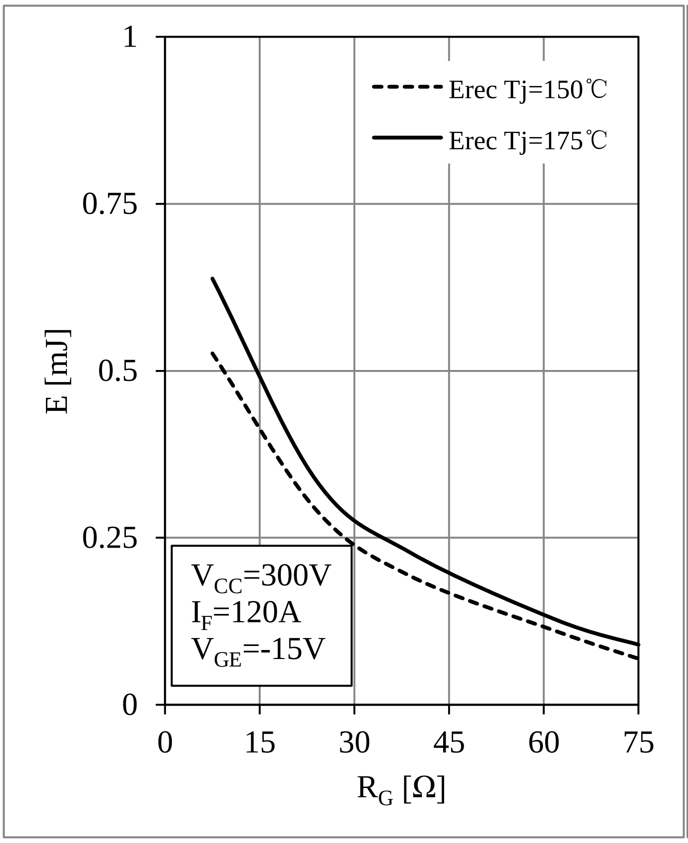


Fig 11. Diode Switching Loss vs. R_G

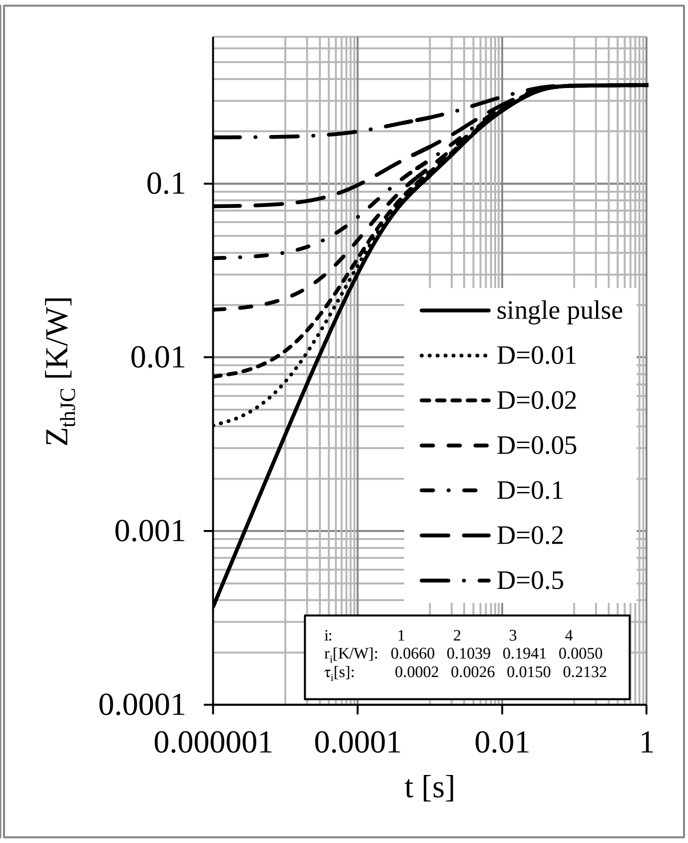
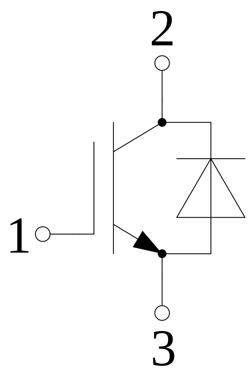


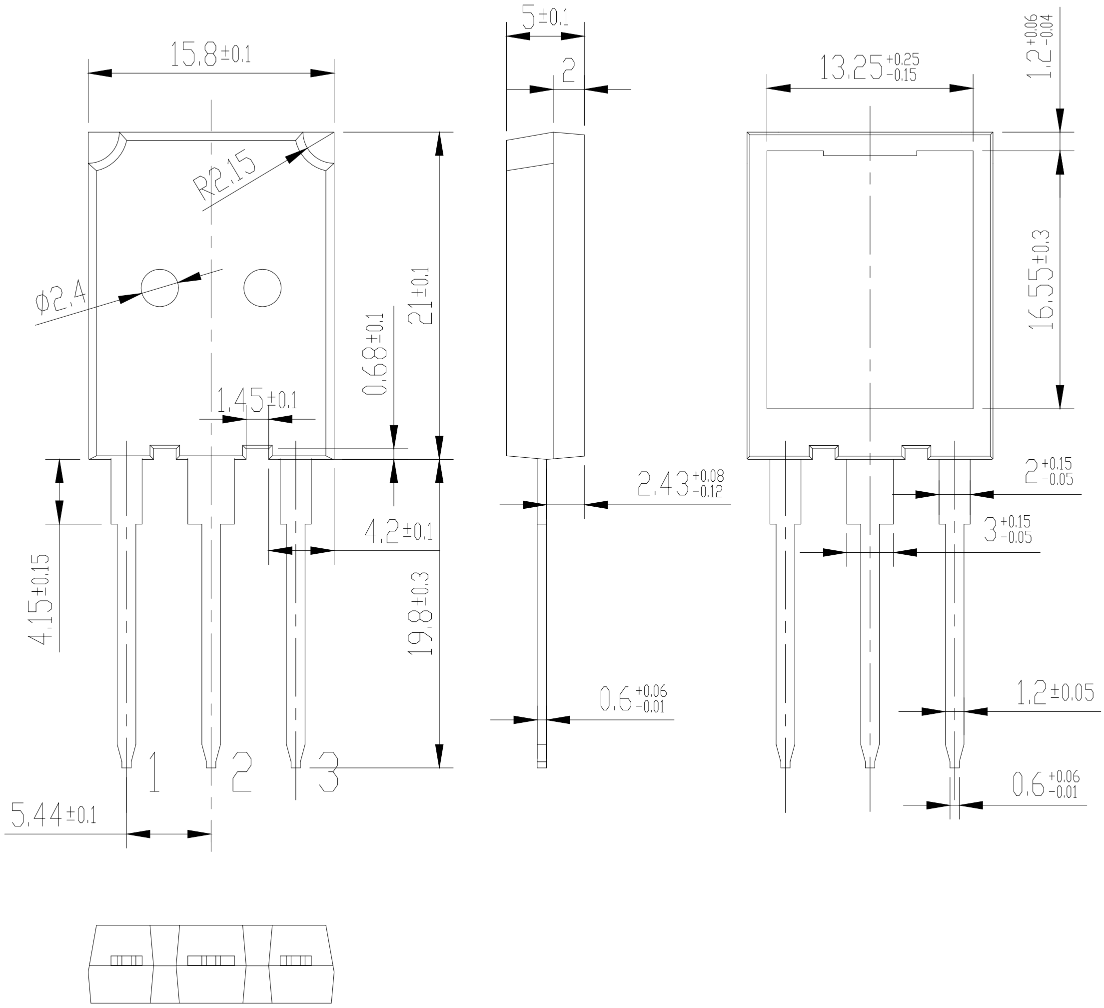
Fig 12. Diode Transient Thermal Impedance

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



Terms and Conditions of Usage

The data contained in this product datasheet is exclusively intended for technically trained staff. you and your technical departments will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to such application.

This product data sheet is describing the characteristics of this product for which a warranty is granted. Any such warranty is granted exclusively pursuant the terms and conditions of the supply agreement. There will be no guarantee of any kind for the product and its characteristics.

Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of our product, please contact the sales office, which is responsible for you (see www.powersemi.cc), For those that are specifically interested we may provide application notes.

Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you.

Should you intend to use the Product in aviation applications, in health or live endangering or life support applications, please notify.

If and to the extent necessary, please forward equivalent notices to your customers.
Changes of this product data sheet are reserved.